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Electronic Version 1.0.3

Stylesheet Version: 1.0

Submission Type: Utility

Number:

INGINE

Patent Filing

Attorney Docket

BUR920010100

METHOD OF CONNECTING CORE I/O PINS TO BACKSIDE CHIP I/O PADS

First Named Inventor: Joseph ladanza

ESUBMITTED BY

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A. Henkler /s/

Date Signed: 20020226

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Attached Files:

declaration

01-0100_Declaration.1.tif

declaration

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BUR920010100US1apds.xml

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01-0100_Declaration.1.tif

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Assignee: International Business Machines Corporation Assignee Address: Armonk, NY 10504

Docket No. BUR920010100U:

Declaration and Power of Attorney For Patent Application **English Language Declaration**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

· I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and f which a patent is sought on the invention entitled METHOD OF CONNECTING CORE I/O PINS TO BACKSIDE CHIP I/O PADS

the specification of which (check one) is attached hereto. ☐ was filed on as United States Application No. or PCT Internations Application Number and was amended on (if applicable) I hereby state that I have reviewed and understand the contents of the above identified specificatio including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all informatic known to me to be material to patentability as defined in Title 37, Code of Federal Regulation Section 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d) Section 365(b) of any foreign application(s) for patent or inventor's certificate, or Section 365(a) any PCT International application which designated at least one country other than the United State listed below and have also identified below, by checking the box, any foreign application for patent inventor's certificate or PCT International application having a filing date before that of the application on which priority is claimed. Prior Foreign Application(s) Priority Not Claime (Number) (Country) (Day/Month/Year Filed) (Number) (Country)

(Day/Month/Year Filed)

(Application Serial No.)	(Filing Date)	-
(Application Serial No.)	(Filing Date)	<u>.</u>
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Jnited States or PCT International	nch of the claims of this ap application in the manner	g the United States, listed below a pplication is not disclosed in the p provided by the first paragraph of United States Patent and Trad m
Instract as the subject matter of ear Juited States or PCT International J.S.C. Section 112, I acknowledge Office all information known to me Section 1.56 which became available or PCT International filing date of the (Application Serial No.)	ach of the claims of this ap application in the manner to the duty to disclose to the to be material to patental to between the filing date of	pplication is not disclosed in the p provided by the first paragraph of United States Patent and Trad m bility as defined in Title 37, C. F.
Jnited States or PCT International J.S.C. Section 112, I acknowledge office all information known to me Section 1.56 which became available or PCT International filing date of the	ach of the claims of this application in the manner of the duty to disclose to the eto be material to patental le between the filing date of application:	oplication is not disclosed in the p provided by the first paragraph of United States Patent and Trad m bility as defined in Title 37, C. F. If the prior application and the nation (Status)

I hereby declare that all statements made herein of my own knowledge are true and that a statements made on information and belief are believed to be true; and further that these statement were made with the knowledge that willful false statements and the like so made are punishable be fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that suc willful false statements may jeopardize the validity of the application or any patent issued thereon.

(patented, pending, abandoned)

POWER OF ATTOR	NEY: As a named inventor,	I hereby appoint	the following	attorney(s)	and/
agent(s) to prosecute	this application and transact	all business in th	ne Patent and	Trademark	Offic
connected therewith.	(list name and registration numb	oer)			
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